## **Jetting Paste** PicoShot<sup>®</sup> NC-5M **Mycronic Approved**

Required

roven:

>30 Million Dots/Syringe

in Lab Testing

- Jetting solder paste designed and approved for Mycronic MY600 and MY700 jetting systems Type 5
  - Standard metal load: 85%
- No-clean solder paste with identical flux chemistry to Indium8.9HF Solder Paste
- Exceptional jetting performance for halogen-free and lead-free paste
  - Consistent precision deposition (x, y) targeting
  - Jetting life (syringe) >8 hours
- Reduces head-in-pillow (HIP) defects
- · Eliminates or significantly reduces graping
- Minimizes reflow spatter
- Standard allov: SAC305
  - Additional allovs available for site-specific qualifications upon request. Please contact an Indium Corporation Technical Support Engineer for more information

## Contact our engineers: askus@indium.com Learn more: www.indium.com/jetting-paste

All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified. Indium Corporation is an ISO 9001:2015 registered company.

Form No. 100130 B0

## Jetting Paste **PicoShot**<sup>®</sup> WS-5M Mycronic Approved

- Jetting solder paste designed and approved for Mycronic MY600 and MY700 jetting systems
  - Standard metal load: 84%
  - Standard alloy: Sn63
    - Additional alloys available for site-specific qualifications upon request. Please contact an Indium Corporation Technical Support Engineer for more information
- Water-soluble jetting solder paste with a flux chemistry identical to Indium6.6HF
- Exceptional jetting performance for a water-soluble paste
- Minimal slumping at fine pitches
- · Exceptional dot size control



Scan for technical paper with supporting data.

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ours

Long Usage

(Svringe)